

MOSFET

OptiMOS[™] 5 Power-Transistor, 100 V

Features

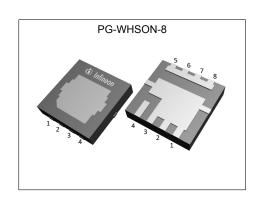
- Optimized for high performance SMPS, e.g. syncronous rectification
- N-channel100% avalanche tested
- Superior thermal resistance
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

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Parameter	Value	Unit					
$V_{ t DS}$	100	V					
R _{DS(on),max}	6.5	mΩ					
I _D	85	A					
Qoss	40	nC					
Q _G (0V10V)	34	nC					











Type / Ordering Code	Package	Marking	Related Links
IQE065N10NM5SC	PG-WHSON-8	F	-

OptiMOS[™] 5 Power-Transistor, 100 V



Table of Contents

escription1
aximum ratings 3
ermal characteristics
ectrical characteristics
ectrical characteristics diagrams 6
nckage Outlines
evision History
ademarks13
sclaimer

OptiMOS[™] 5 Power-Transistor, 100 V IQE065N10NM5SC



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	Cumbal		Value	s	1114	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - - -	- - -	85 60 46 13	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =6 V, T_{C} =100 °C V_{GS} =10V, T_{A} =25°C, R_{thJA} =60°C/W ²)
Pulsed drain current ³⁾	I _{D,pulse}	-	-	340	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	147	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	100 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Doromotor	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	0.8	1.5	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	0.7	-	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area²)	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

OptiMOS[™] 5 Power-Transistor, 100 V IQE065N10NM5SC



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	0		Value	s	1114	
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	100	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.2	3.0	3.8	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=48~\mu{\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μA	V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	5.7 7.2	6.5 11	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =6 V, I _D =10 A
Gate resistance	R _G	-	0.7	-	Ω	-
Transconductance	g fs	-	55	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 20 A$

Table 5 **Dynamic characteristics**

Devementar	Comphal	Values			11:4	Nata (Tant Oan dition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	2300	3000	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	340	440	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	18	32	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	8.9	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	3.8	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	21.1	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	7.5	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Cumbal		Values			Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	10.1	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	Q _{g(th)}	-	6.8	-	nC	V _{DD} =50 V, I _D =20 A, V _{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q _{gd}	-	7.4	11.1	nC	V _{DD} =50 V, I _D =20 A, V _{GS} =0 to 10 V
Switching charge	Q _{sw}	-	10.7	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Q g	-	34	43	nC	V _{DD} =50 V, I _D =20 A, V _{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.4	-	V	V _{DD} =50 V, I _D =20 A, V _{GS} =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	29	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	40	53	nC	V _{DS} =50 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

OptiMOSTM 5 Power-Transistor, 100 V

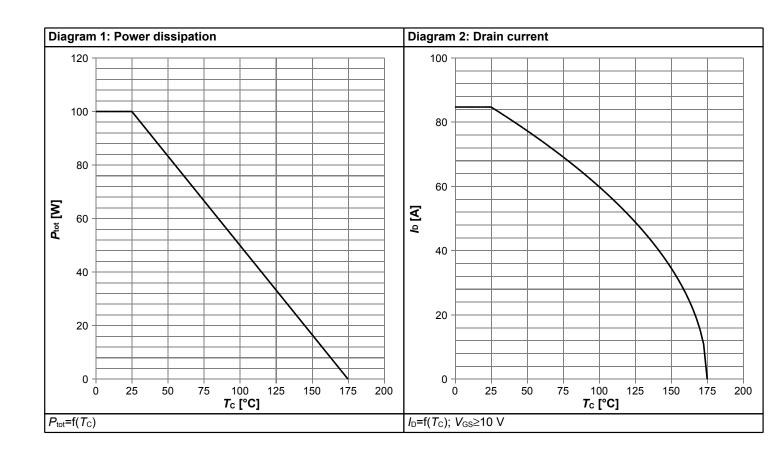


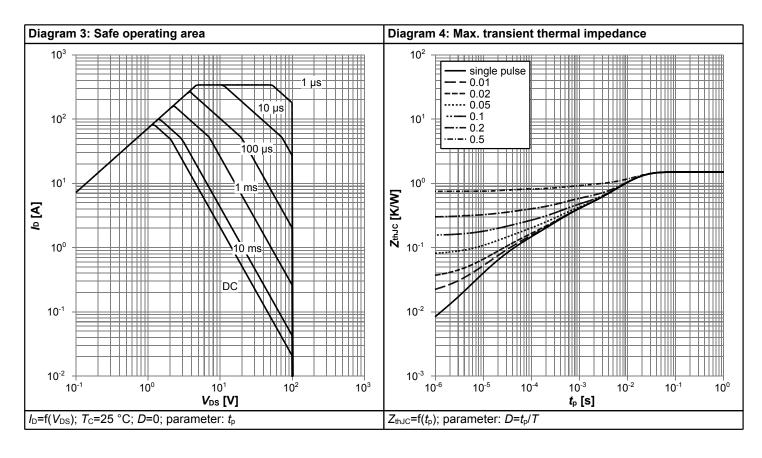
Table 7 Reverse diode

Parameter	C: mah al		Values			Nata / Tank Oam distant
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	74	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	340	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.83	1.1	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	36	72	ns	V _R =50 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	40	80	nC	V _R =50 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

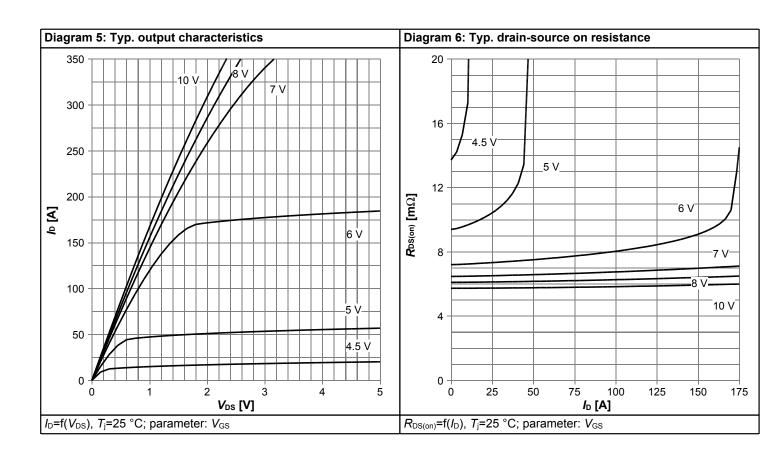


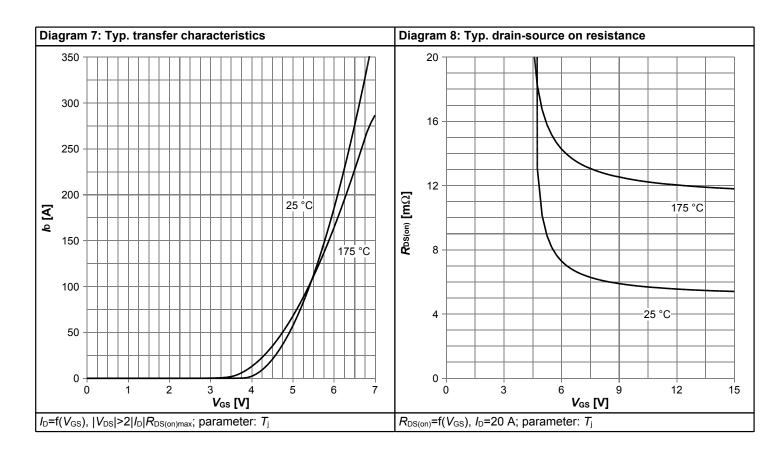
4 Electrical characteristics diagrams



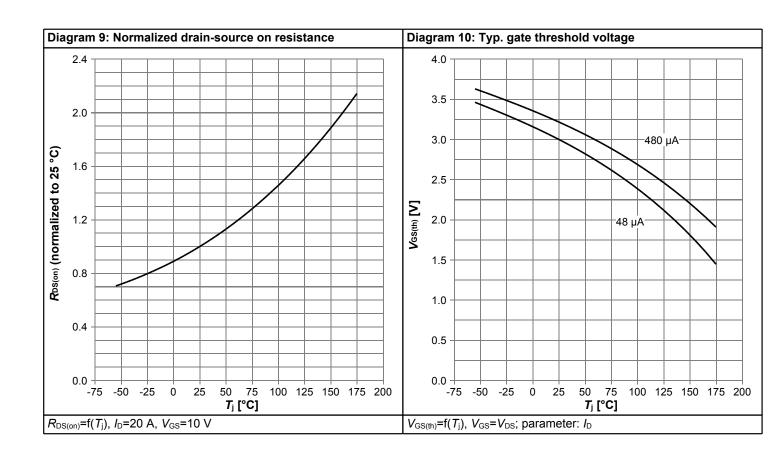


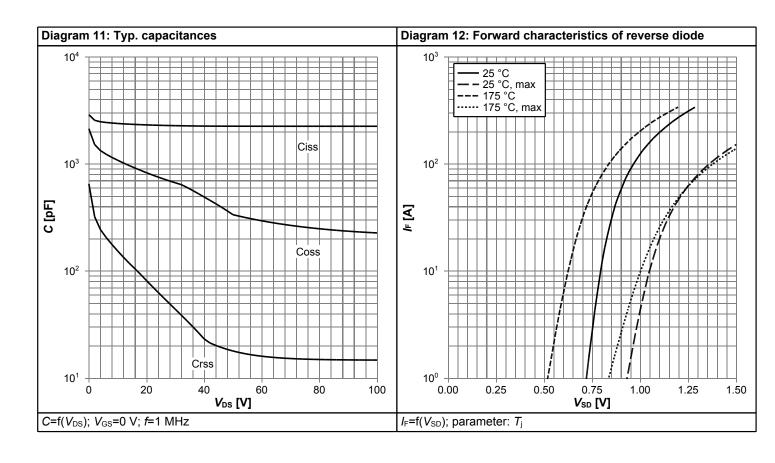




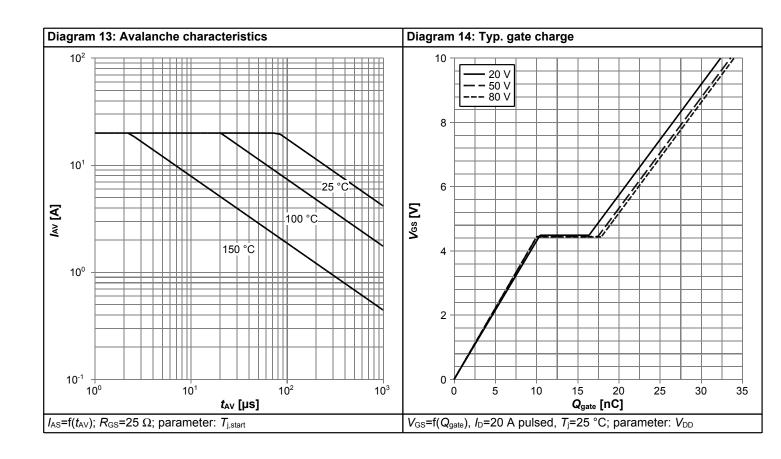


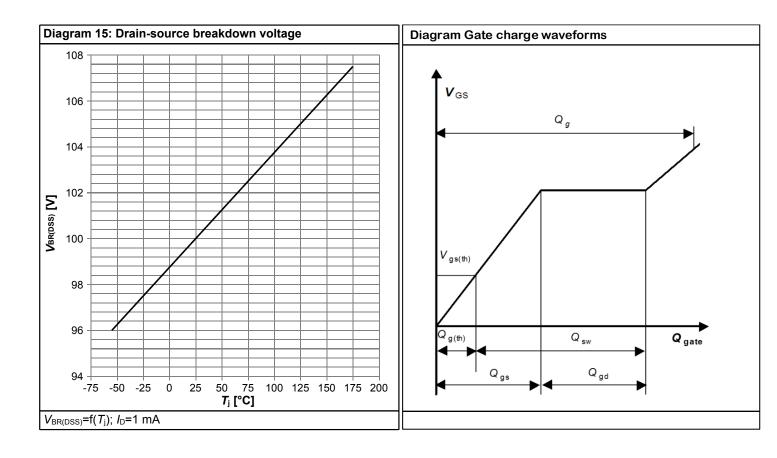






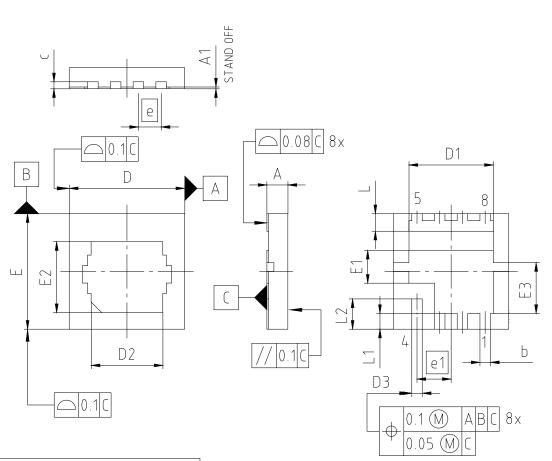








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-WHS	PG-WHSON-8-U01				
DIMENSIONS	MILLIMETERS					
DIMENSIONS	MIN.	MAX.				
Α		0.75				
A1	0	0.05				
b	0.20	0.40				
С	0.10	0.30				
D	3.20	3.40				
D1	2.31	2.51				
D2	1.95	2.25				
D3	0.20	0.40				
E	3.20	3.40 1.04				
E1	0.84					
E2	1.93	2.23				
E3	1.35	1.55				
е	0.65					
e1	0.	975				
L	0.40	0.60				
L1	0.35	0.55				
L2	0.77	0.97				

Figure 1 Outline PG-WHSON-8, dimensions in mm



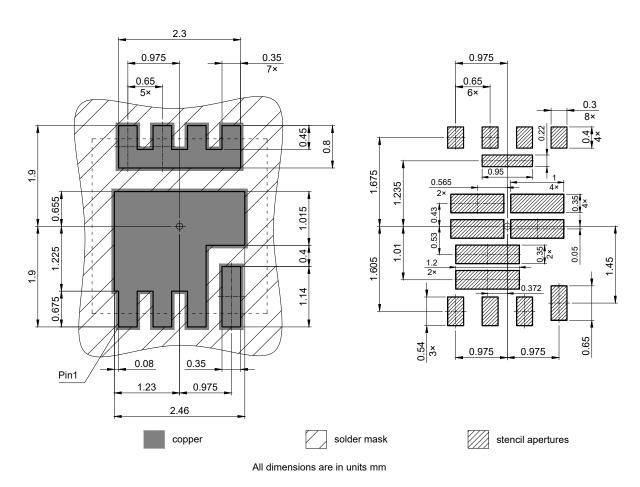


Figure 2 Outline Footprint (PG-WHSON-8-1), dimensions in mm



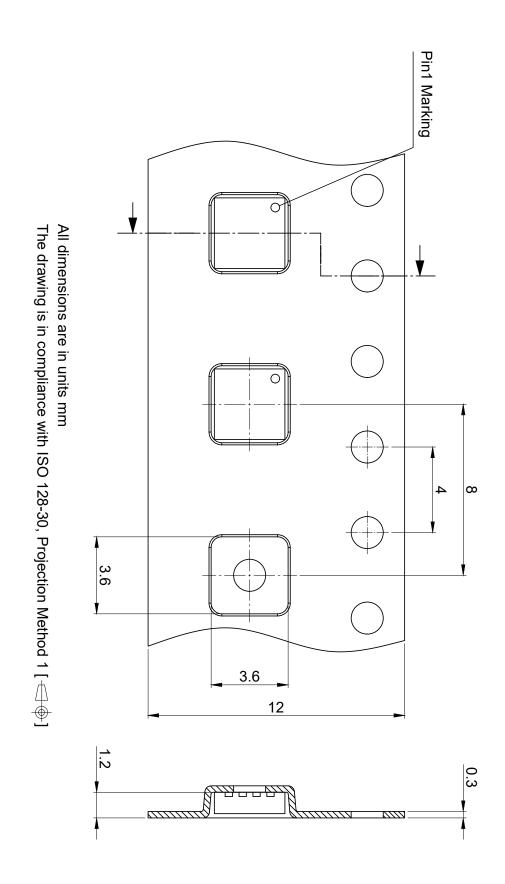


Figure 3 Outline Tape (PG-WHSON-8-1), dimensions in mm

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Revision History

IQE065N10NM5SC

Revision: 2022-05-02, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)	
2.0	2022-05-02	Release of final version	

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